L	Hits	Search Text	DB	Time stamp
Number				
1	0	semiconductor near10 packag\$3 and chip	USPAT;	2004/09/23
		and metal adj plates and plugs and pads	EPO; JPO; DERWENT	11:56
2	3	semiconductor near10 packag\$3 and chip	USPAT;	2004/09/23
		and metal near5 plates and plugs and pads	EPO; JPO; DERWENT	11:59
3	32	semiconductor near10 packag\$3 and chip and plates and plugs and pads	USPAT; EPO; JPO; DERWENT	2004/09/23 11:59
4	29	(semiconductor near10 packag\$3 and chip and plates and plugs and pads) not (semiconductor near10 packag\$3 and chip and metal near5 plates and plugs and pads)	USPAT; EPO; JPO; DERWENT	2004/09/23